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DATA SHEET

PART NO. : L-C170KGCT

REV : A / 02

CUSTOMER'S APPROVAL : _____

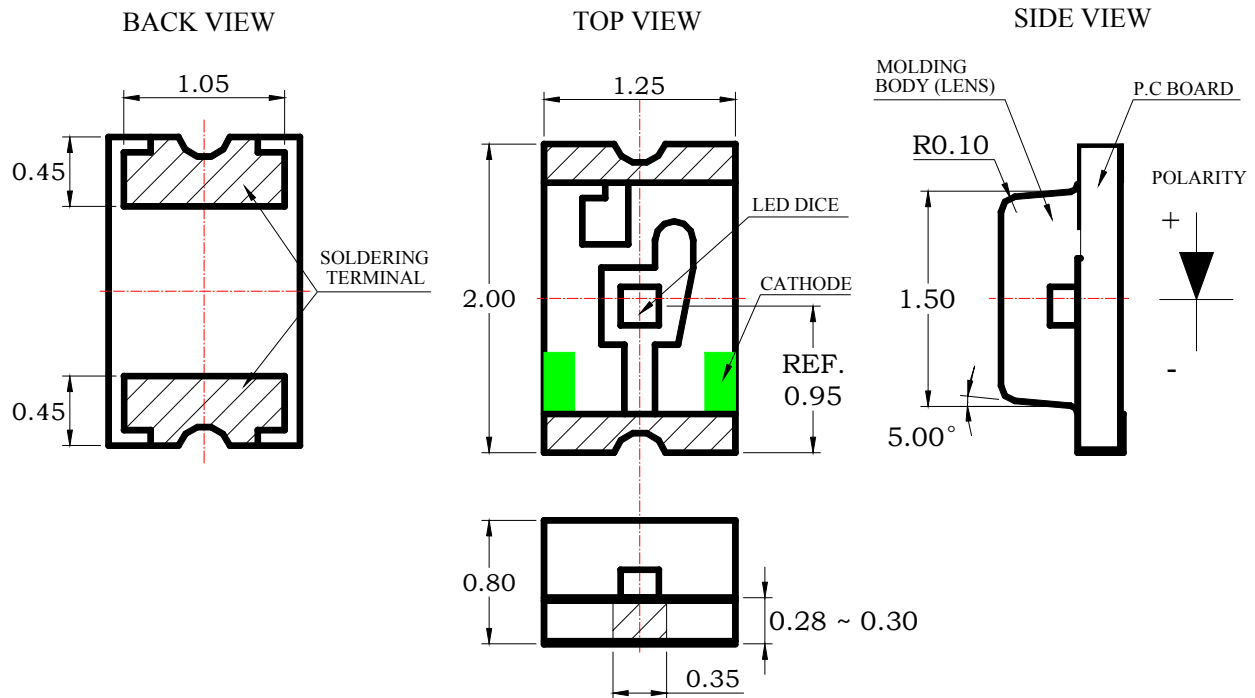
DCC : _____

DRAWING NO. : DS-72-03-0005

DATE : 2004-04-04

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● PACKAGE OUTLINE DIMENSIONS



Notes:

1. All dimensions are in millimeters.
2. Tolerance is $\pm 0.1\text{mm}$ (.004") unless otherwise noted.

● Features

- * Top view, wide view angle, single color Chip LED.
- * Package in 8mm tape on 7" diameter reels.
- * Compatible with automatic Pick & Place equipment.
- * Compatible with Infrared and Wave soldering reflow solder processes.
- * EIA STD package.
- * I.C. compatible.

● **Chip Materials**

- * Dice Material : AlInGaP
- * Light Color : Super Green
- * Lens Color : Water Clear

● **Absolute Maximum Ratings(Ta=25°C)**

Symbol	Parameter	Rating	Unit
PD	Power Dissipation	60	mW
IPF	Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	60	mA
IF	Continuous Forward Current	30	mA
-	De-rating Linear From 25°C	0.25	mA/°C
VR	Reverse Voltage	5	V
ESD	Electrostatic Discharge Threshold(HBM) ^{Note A}	2000	V
Topr	Operating Temperature Range	-40 ~ +85	°C
Tstg	Storage Temperature Range	-40 ~ +85	°C
-	Wave Soldering Condition (Two times Max.)	260 (for 5 seconds)	°C
-	Infrared Soldering Condition (Two times MAX.)	240 (for 10 seconds)	°C

Note A :

HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

● **Electro-Optical Characteristics(Ta=25°C)**

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Luminous Intensity	IV	16.0	30.0		mcd	IF=20mA
Viewing Angle	2 θ 1/2		130		deg	Note 2
Peak Emission Wavelength	λ p		571		nm	Measurement @Peak
Dominant Wavelength	λ d		570		nm	IF=20mA
Spectral Line Half-Width	Δ λ		15		nm	
Forward Voltage	VF		2.05	2.4	V	IF =20mA
Reverse Current	IR			100	μ A	VR = 5V

Notes:

1. Luminous intensity is measured with a light sensor and filter combination that proximities the CIE eye-response curve.
2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
3. The dominant wavelength λ_d is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
4. Caution in ESD :
Static Electricity and surge damages the LED. It is recommend use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
5. Major standard testing equipment by "Instrument System" Model : CAS140B Compact Array Spectrometer and "KEITHLEY" Source Meter Model : 2400.

● Typical Electro-Optical Characteristics Curves

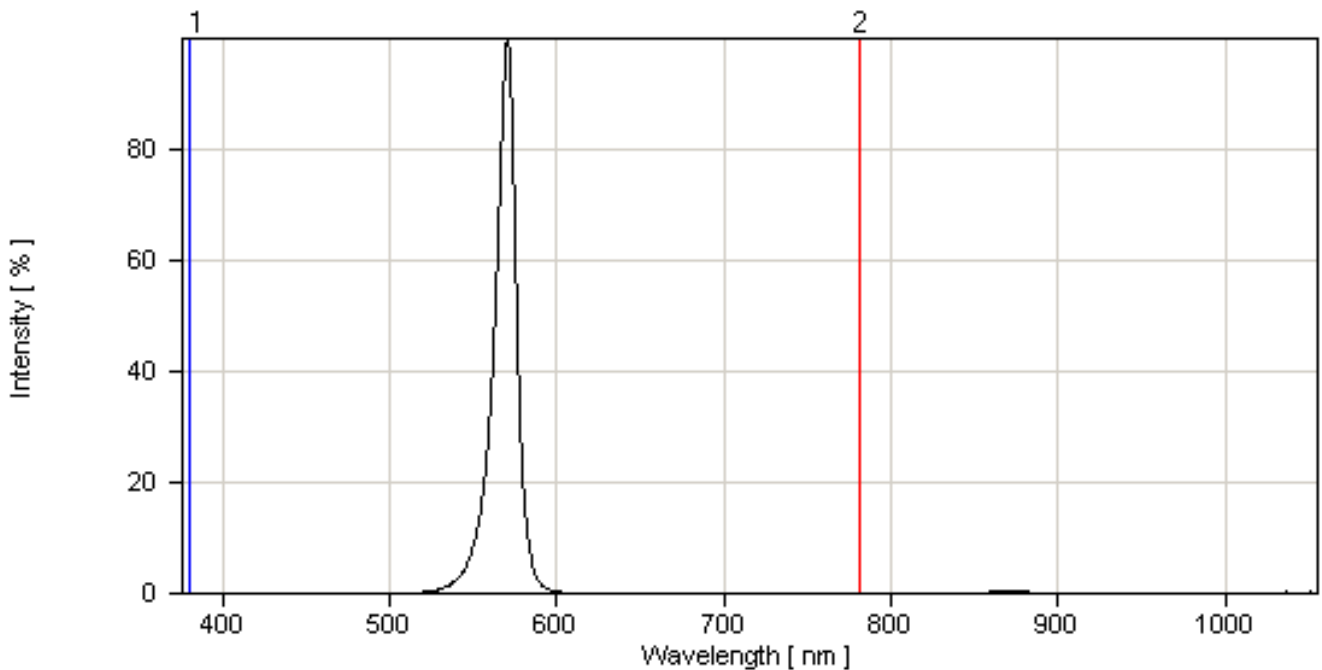


Fig.1 Relative Intensity vs. Wavelength

● Typical Electro-Optical Characteristics Curves

(25°C Ambient Temperature Unless Otherwise Noted)

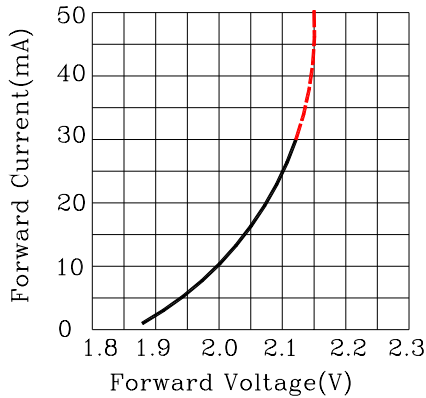


Fig.2 Forward Current vs.Forward Voltage

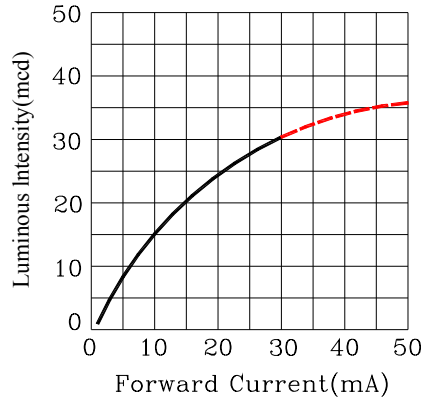


Fig.3 Luminous Intensity vs.Forward Current

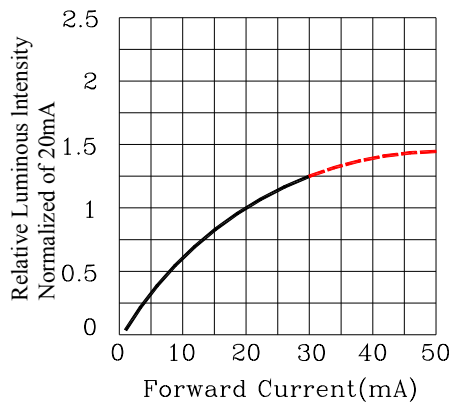


Fig.4 Relative Luminous Intensity vs.Forward Current

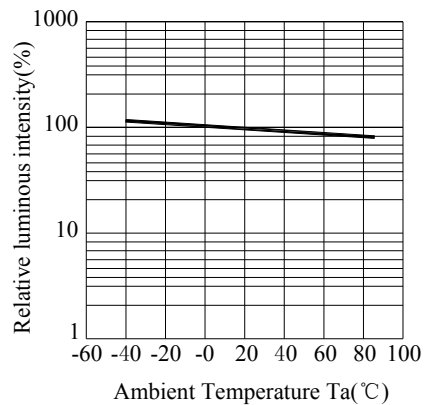


Fig.5 Luminous Intensity vs.Ambient Temperature

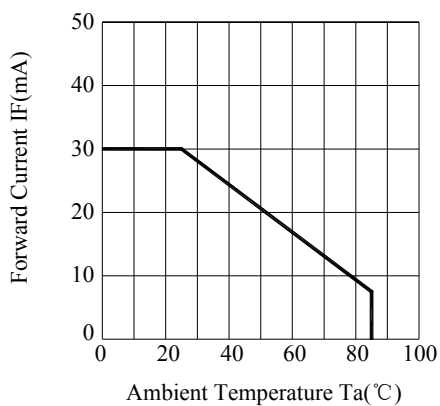


Fig.6 Forward Current Derating Curve

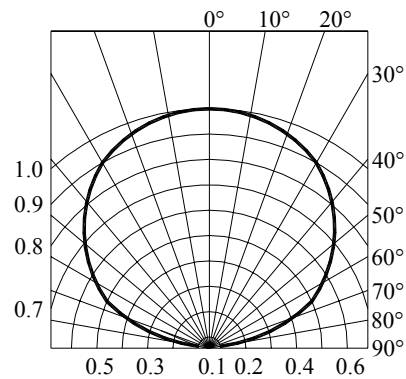


Fig.7 Relative Intensity vs.Angle

● Label Explanation

BATCH: L1 B9 AC

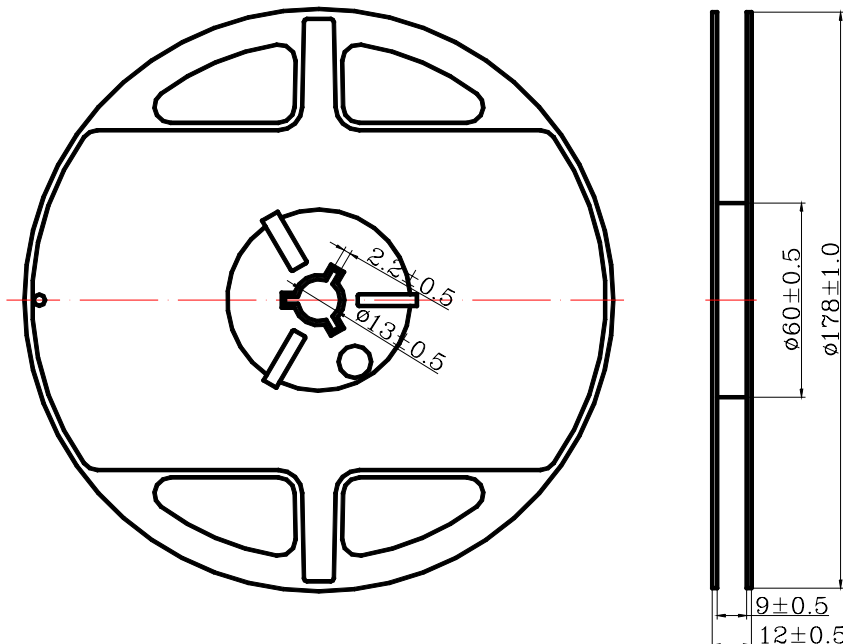
L1: Luminous Intensity Code

B9: Forward Voltage Code

AC: Dom Wavelength Code



● Reel Dimensions

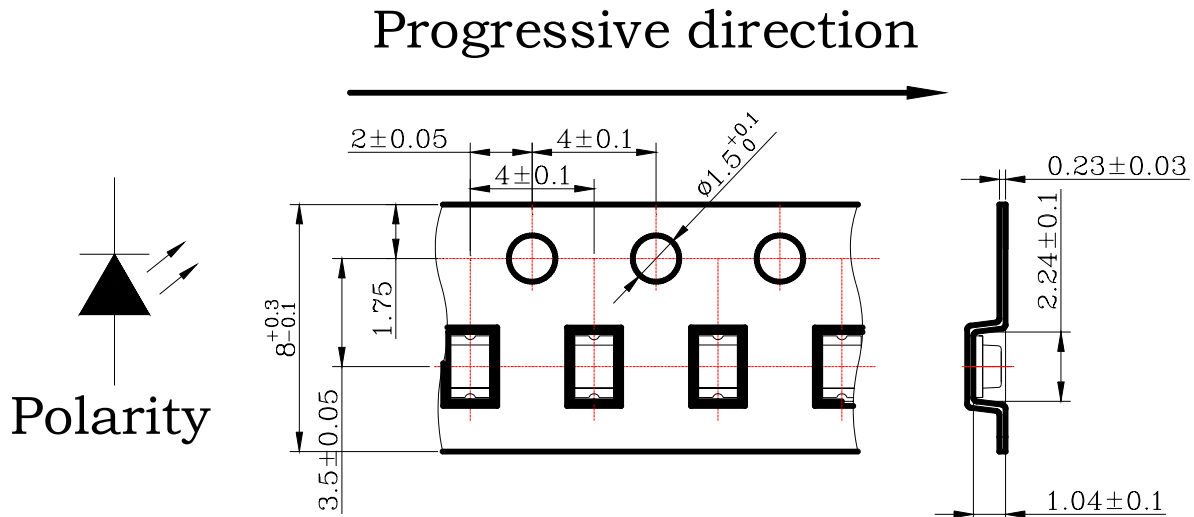


Notes:

1. Taping Quantity : 3000PCS

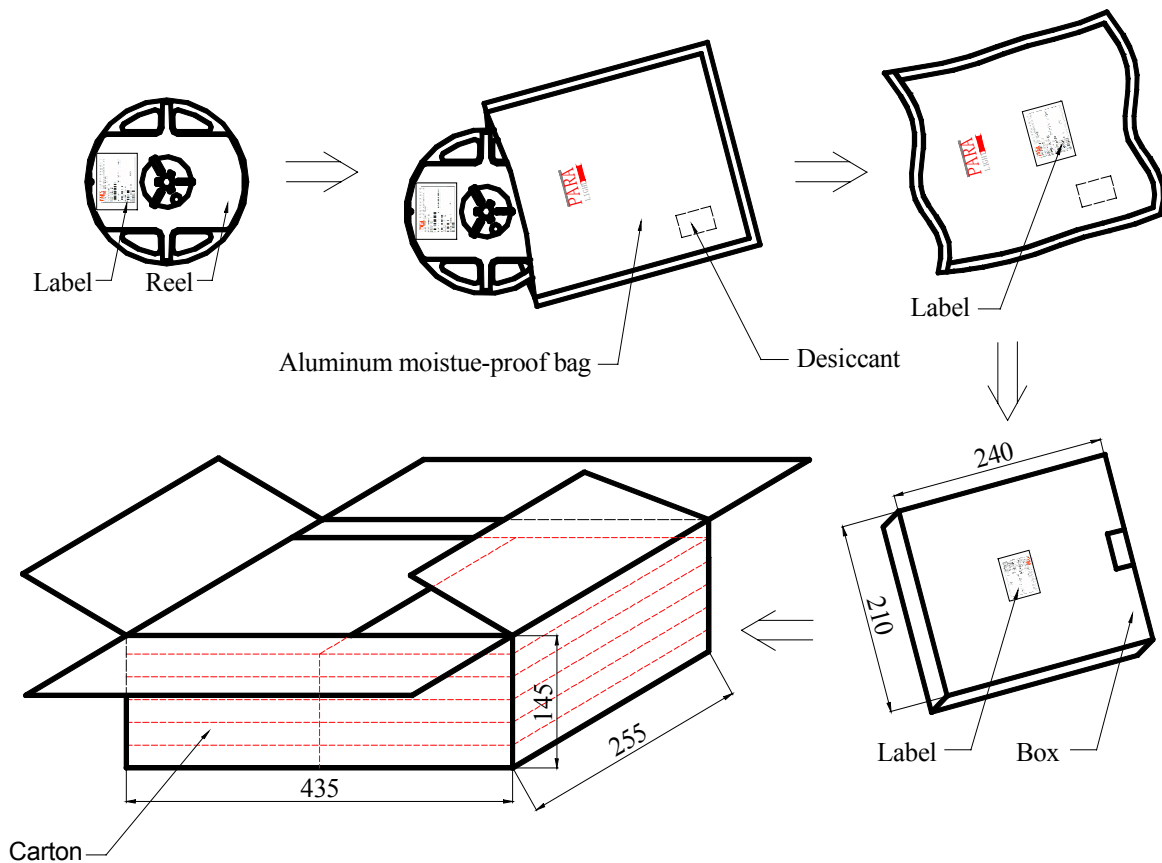
2. The tolerances unless mentioned is $\pm 0.1\text{mm}$, Angle $\pm 0.5^\circ$, Unit : mm.

● Package Dimensions Of Tape And Reel



Notes: All dimensions are in millimeters.

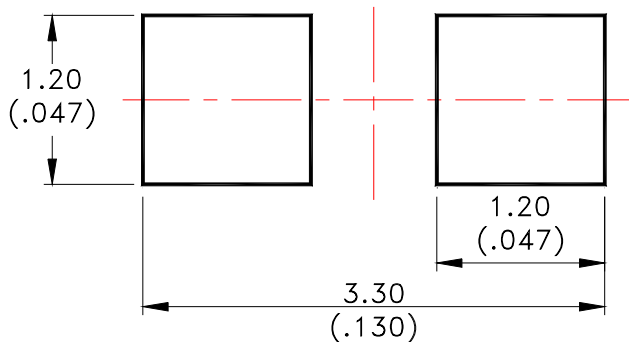
Moisture Resistant Packaging



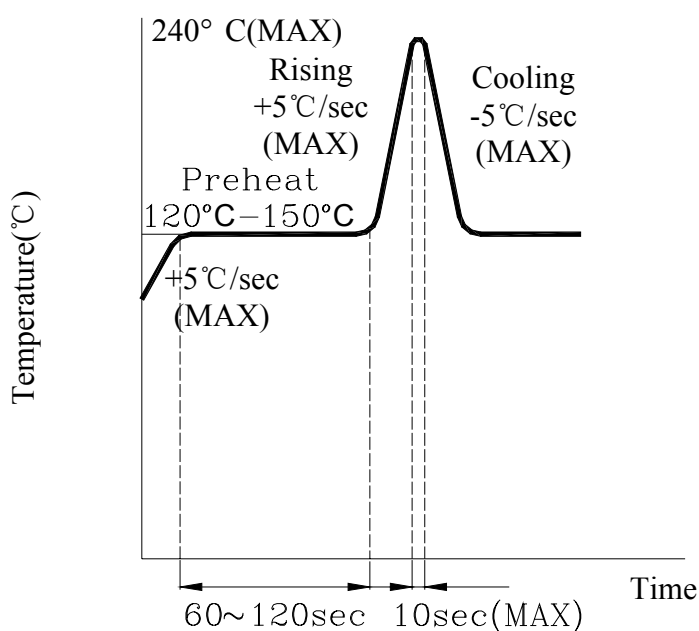
Notes : One reel in a bag, one bag in a inner box, ten inner boxes in a carton. Unit : mm.

● Cleaning

- * If cleaning is required, use the following solutions for less than 1 minute and less than 40°C.
- * Appropriate chemicals: Ethyl alcohol and isopropyl alcohol.
- * Effect of ultrasonic cleaning on the LED resin body differs depending on such factors as the oscillator output, size of PCB and LED mounting method. The use of ultrasonic cleaning should be enforced at proper output after confirming there is no problem.

● Suggest Soldering Pad Dimensions

Direction of PWB camber
and go to reflow furnace

● Suggest IR Reflow Soldering Profile Condition:

● **Bin Code List**

Luminous Intensity(IV), Unit:mcd@20mA		
Bin Code	Min	Max
M	16.0	32.0
N	25.0	50.0
P	40.0	80.0

Forward Voltage(VF), Unit:V@20mA		
Bin Code	Min	Max
4	1.85	2.05
5	1.95	2.15
6	2.05	2.25
7	2.15	2.35

Including test tolerance

Including test tolerance

Dominant Wavelength (Hue),Unit: nm@20mA		
Bin Code	Min	Max
GA	566	571
GB	569	574

Including ± 1 nm test tolerance

● **CAUTIONS**

1.Application Limitation :

The LED's described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household application).Consult PARA's sales in advance for information on application in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LED's may directly jeopardize life or health (such as airplanes, automobiles, traffic control equipment, life support system and safety devices).

2.Storage :

Before opening the package :

The LEDs should be kept at 5°C to 30°C or less and 85%RH or less. The LEDs should be used within a year.

After opening the package :

The LEDs should be kept at 5°C to 30°C or less and 70%RH or less. The LEDs should be soldered within 168 hours(7 days) after opening the package.

Please avoid rapid transitions in ambient temperature in high humidity environments where condensation may occur.

3.Soldering

Do not apply any stress to the lead frame during soldering while the LED is at high temperature.

Recommended soldering condition.

Reflow Soldering :

Pre-heat 120~150°C, 120sec. MAX., Peak temperature : 240°C Max. Soldering time : 10 sec Max.

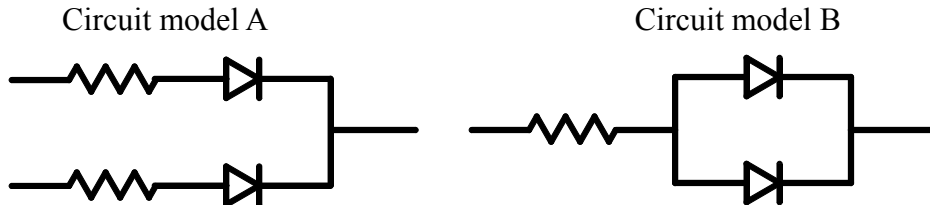
Soldering Iron : (Not recommended)

Temperature 300°C Max., Soldering time : 3 sec. Max.(one time only), power dissipation of iron : 20W Max. use SN60 solder of solder with silver content and don't to touch LED lens when soldering.

Wave soldering :

Pre-heat 100°C Max, Pre-heat time 60 sec. Max, Solder wave 260°C Max, Soldering time 5 sec. Max. performed consecutively cooling process is required between 1st and 2nd soldering processes.

4. Drive Method



(A) Recommended circuit.

(B) The difference of brightness between LED's could be found due to the Vf-If characteristics of LED.

5. Reliability Test

Classification	Test Item	Test Condition	Reference Standard
Endurance Test	Operation Life	Ta= Under Room Temperature As Per Data Sheet Maximum Rating *Test Time= 1000HRS (-24HRS,+72HRS)*@20mA.	MIL-STD-750D:1026 (1995) MIL-STD-883D:1005 (1991) JIS C 7021:B-1 (1982)
	High Temperature High Humidity Storage	IR-Reflow In-Board, 2 Times Ta= 65±5°C, RH= 90~95% *Test Time= 1000HRS±2HRS	MIL-STD-202F:103B(1980) JIS C 7021:B-11(1982)
	High Temperature Storage	Ta= 105±5°C Test Time= 1000HRS (-24HRS,72HRS)	MIL-STD-883D:1008 (1991) JIS C 7021:B-10 (1982)
	Low Temperature Storage	Ta= -55±5°C *Test Time=1000HRS (-24HRS,72H RS)	JIS C 7021:B-12 (1982)
Environmental Test	Temperature Cycling	105±5°C -55±5°C 10mins 10mins 100 Cycles	MIL-STD-202F:107D (1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1010 (1991) JIS C 7021:A-4(1982)
	Thermal Shock	IR-Reflow In-Board, 2 Times 105±5°C -55°C±5°C 10mins 10mins 100 Cycles	MIL-STD-202F:107D(1980) MIL-STD-750D:1051(1995) MIL-STD-883D:1011 (1991)
	Solder Resistance	Tsol= 260 ± 5°C Dwell Time= 10 ± 1sec	MIL-STD-202F:210A(1980) MIL-STD-750D:2031(1995) JIS C 7021:A-1(1982)
	Solder ability	Tsol= 235 ± 5°C Immersion time 2±0.5 sec Immersion rate 25±2.5 mm/sec Coverage ≥95% of the dipped surface	MIL-STD-202F:208D(1980) MIL-STD-750D:2026(1995) MIL-STD-883D:2003(1991) IEC 68 Part 2-20 JIS C 7021:A-2(1982)

6. Others:

The appearance and specifications of the product may be modified for improvement without notice.

● PART NO. SYSTEM :

L - C 1 7 0 X C X X - X X X X

XXXX : Special specification for customer

T : Taping for 7 inch reel
 TC : Taping for 13 inch reel
 TH : IV half binning
 TP : Wavelength binning

Lens color
 C : Water Clear
 W : White Diffused
 T : Color Transparent
 D : Color Diffused

G : Gap 570nm Green
 Y : GaAsp 585 nm Yellow
 E : GaAsp 620 nm Orange
 SR : GaAlAs 634 nm Red
 KG : AllnGap 570nm Super Green
 KY : AllnGap 590nm Super Yellow
 KF : AllnGap 605nm Super Amber
 KR : AllnGap 630 nm Super Red
 LB : InGaN 470nm Blue
 LG : InGaN 525nm Green

0 : Single chip
 1/2 : Super thin single chip
 5/6 : Dual chip
 F : Three chip(Full color)

150 : 1206 1.1T Type
 170 : 0805 0.8T Type
 191 : 0603 0.6T Type
 192 : 0603 0.4T Type
 110 : 1206 1.0T Type

C : Top View Type
 S : Side View Type